

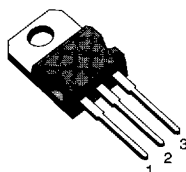
# N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTOR

| TYPE      | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-----------|------------------|---------------------|----------------|
| STP6N50   | 500 V            | < 1.1 Ω             | 6 A            |
| STP6N50FI | 500 V            | < 1.1 Ω             | 3.8 A          |

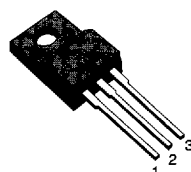
- TYPICAL R<sub>DS(on)</sub> = 0.93 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- APPLICATION ORIENTED CHARACTERIZATION

## APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITCH MODE POWER SUPPLIES (SMPS)
- CHOPPER REGULATORS, CONVERTERS, MOTOR CONTROL, LIGHTING FOR INDUSTRIAL AND CONSUMER ENVIRONMENT

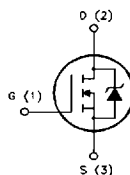


TO-220



ISOWATT220

## INTERNAL SCHEMATIC DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

| Symbol              | Parameter                                             | Value      |           | Unit |
|---------------------|-------------------------------------------------------|------------|-----------|------|
|                     |                                                       | STP6N50    | STP6N50FI |      |
| V <sub>DS</sub>     | Drain-source Voltage (V <sub>GS</sub> = 0)            | 500        |           | V    |
| V <sub>DGR</sub>    | Drain- gate Voltage (R <sub>GS</sub> = 20 kΩ)         | 500        |           | V    |
| V <sub>GS</sub>     | Gate-source Voltage                                   | ± 20       |           | V    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 25 °C  | 6          | 3.8       | A    |
| I <sub>D</sub>      | Drain Current (continuous) at T <sub>c</sub> = 100 °C | 3.8        | 2.4       | A    |
| I <sub>DM</sub> (*) | Drain Current (pulsed)                                | 24         | 24        | A    |
| P <sub>tot</sub>    | Total Dissipation at T <sub>c</sub> = 25 °C           | 100        | 40        | W    |
|                     | Derating Factor                                       | 0.8        | 0.32      | W/°C |
| V <sub>ISO</sub>    | Insulation Withstand Voltage (DC)                     | —          | 2000      | V    |
| T <sub>stg</sub>    | Storage Temperature                                   | -65 to 150 |           | °C   |
| T <sub>j</sub>      | Max. Operating Junction Temperature                   | 150        |           | °C   |

(\*) Pulse width limited by safe operating area

## THERMAL DATA

|                |                                                |     | TO-200 | ISOWATT220 |      |
|----------------|------------------------------------------------|-----|--------|------------|------|
| $R_{thj-case}$ | Thermal Resistance Junction-case               | Max | 1.25   | 3.12       | °C/W |
| $R_{thj-amb}$  | Thermal Resistance Junction-ambient            | Max | 62.5   |            | °C/W |
| $R_{thc-sink}$ | Thermal Resistance Case-sink                   | Typ | 0.5    |            | °C/W |
| $T_j$          | Maximum Lead Temperature For Soldering Purpose |     | 300    |            | °C   |

## AVALANCHE CHARACTERISTICS

| Symbol   | Parameter                                                                                                                        | Max Value | Unit |
|----------|----------------------------------------------------------------------------------------------------------------------------------|-----------|------|
| $I_{AR}$ | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max, $\delta < 1\%$ )                              | 6         | A    |
| $E_{AS}$ | Single Pulse Avalanche Energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50\text{ V}$ )                     | 300       | mJ   |
| $E_{AR}$ | Repetitive Avalanche Energy (pulse width limited by $T_j$ max, $\delta < 1\%$ )                                                  | 7         | mJ   |
| $I_{AR}$ | Avalanche Current, Repetitive or Not-Repetitive ( $T_c = 100^\circ\text{C}$ , pulse width limited by $T_j$ max, $\delta < 1\%$ ) | 3.8       | A    |

ELECTRICAL CHARACTERISTICS ( $T_{case} = 25^\circ\text{C}$  unless otherwise specified)

## OFF

| Symbol        | Parameter                                        | Test Conditions                                                                                   | Min. | Typ. | Max.        | Unit                           |
|---------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------|------|------|-------------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source Breakdown Voltage                   | $I_D = 250\text{ }\mu\text{A}$ $V_{GS} = 0$                                                       | 500  |      |             | V                              |
| $I_{DSS}$     | Zero Gate Voltage Drain Current ( $V_{GS} = 0$ ) | $V_{DS} = \text{Max Rating}$<br>$V_{DS} = \text{Max Rating} \times 0.8$ $T_c = 125^\circ\text{C}$ |      |      | 250<br>1000 | $\mu\text{A}$<br>$\mu\text{A}$ |
| $I_{GSS}$     | Gate-body Leakage Current ( $V_{DS} = 0$ )       | $V_{GS} = \pm 20\text{ V}$                                                                        |      |      | $\pm 100$   | nA                             |

## ON (\*)

| Symbol       | Parameter                         | Test Conditions                                                                                                  | Min. | Typ. | Max.       | Unit                 |
|--------------|-----------------------------------|------------------------------------------------------------------------------------------------------------------|------|------|------------|----------------------|
| $V_{GS(th)}$ | Gate Threshold Voltage            | $V_{DS} = V_{GS}$ $I_D = 250\text{ }\mu\text{A}$                                                                 | 2    | 3    | 4          | V                    |
| $R_{DS(on)}$ | Static Drain-source On Resistance | $V_{GS} = 10\text{ V}$ $I_D = 3\text{ A}$<br>$V_{GS} = 10\text{ V}$ $I_D = 3\text{ A}$ $T_c = 100^\circ\text{C}$ |      | 0.93 | 1.1<br>2.2 | $\Omega$<br>$\Omega$ |
| $I_{D(on)}$  | On State Drain Current            | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$<br>$V_{GS} = 10\text{ V}$                                              | 6    |      |            | A                    |

## DYNAMIC

| Symbol       | Parameter                    | Test Conditions                                              | Min. | Typ. | Max. | Unit |
|--------------|------------------------------|--------------------------------------------------------------|------|------|------|------|
| $g_{fs} (*)$ | Forward Transconductance     | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 3\text{ A}$ | 2.5  | 4.5  |      | S    |
| $C_{iss}$    | Input Capacitance            | $V_{DS} = 25\text{ V}$ $f = 1\text{ MHz}$ $V_{GS} = 0$       |      | 800  | 1100 | pF   |
| $C_{oss}$    | Output Capacitance           |                                                              |      | 140  | 190  | pF   |
| $C_{rss}$    | Reverse Transfer Capacitance |                                                              |      | 60   | 80   | pF   |

**ELECTRICAL CHARACTERISTICS** (continued)**SWITCHING ON**

| Symbol                        | Parameter                                                    | Test Conditions                                                                                                         | Min. | Typ.          | Max.      | Unit           |
|-------------------------------|--------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|------|---------------|-----------|----------------|
| $t_{d(on)}$<br>$t_r$          | Turn-on Time<br>Rise Time                                    | $V_{DD} = 250\text{ V}$ $I_D = 3\text{ A}$<br>$R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 3) |      | 40<br>110     | 55<br>150 | ns<br>ns       |
| $(di/dt)_{on}$                | Turn-on Current Slope                                        | $V_{DD} = 400\text{ V}$ $I_D = 6\text{ A}$<br>$R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 5) |      | 85            |           | A/ $\mu$ s     |
| $Q_g$<br>$Q_{gs}$<br>$Q_{gd}$ | Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge | $V_{DD} = 400\text{ V}$ $I_D = 6\text{ A}$ $V_{GS} = 10\text{ V}$                                                       |      | 55<br>9<br>26 | 75        | nC<br>nC<br>nC |

**SWITCHING OFF**

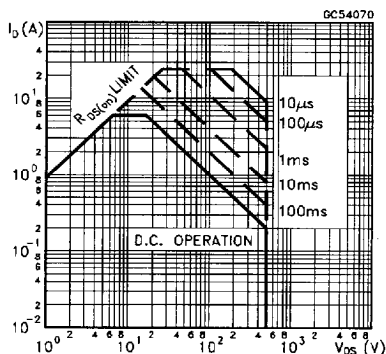
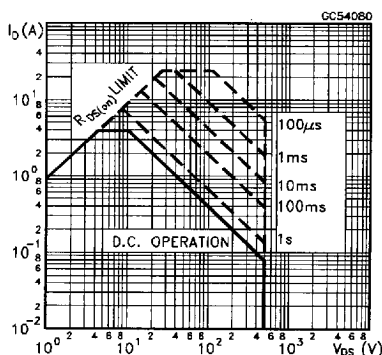
| Symbol                         | Parameter                                             | Test Conditions                                                                                                         | Min. | Typ.             | Max.             | Unit           |
|--------------------------------|-------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------|------|------------------|------------------|----------------|
| $t_{r(off)}$<br>$t_f$<br>$t_c$ | Off-voltage Rise Time<br>Fall Time<br>Cross-over Time | $V_{DD} = 400\text{ V}$ $I_D = 6\text{ A}$<br>$R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$<br>(see test circuit, figure 5) |      | 115<br>35<br>165 | 160<br>50<br>220 | ns<br>ns<br>ns |

**SOURCE DRAIN DIODE**

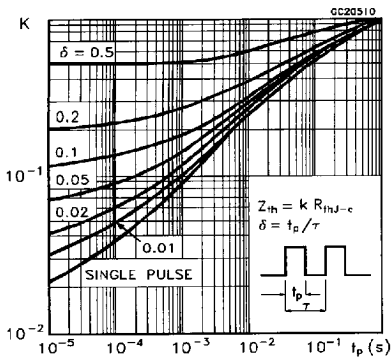
| Symbol                         | Parameter                                                | Test Conditions                                                                                                                               | Min. | Typ. | Max.    | Unit          |
|--------------------------------|----------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|------|------|---------|---------------|
| $I_{SD}$<br>$I_{SDM}(\bullet)$ | Source-drain Current<br>Source-drain Current<br>(pulsed) |                                                                                                                                               |      |      | 6<br>24 | A<br>A        |
| $V_{SD}(\ast)$                 | Forward On Voltage                                       | $I_{SD} = 6\text{ A}$ $V_{GS} = 0$                                                                                                            |      |      | 1.6     | V             |
| $t_{rr}$                       | Reverse Recovery Time                                    | $I_{SD} = 6\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 100\text{ V}$ $T_j = 150^\circ\text{C}$<br>(see test circuit, figure 5) |      | 550  |         | ns            |
| $Q_{rr}$                       | Reverse Recovery Charge                                  |                                                                                                                                               |      | 6.9  |         | $\mu\text{C}$ |
| $I_{RRM}$                      | Reverse Recovery Current                                 |                                                                                                                                               |      | 25   |         | A             |

(\*) Pulsed: Pulse duration  $\tau = 300\ \mu\text{s}$ , duty cycle 1.5 %

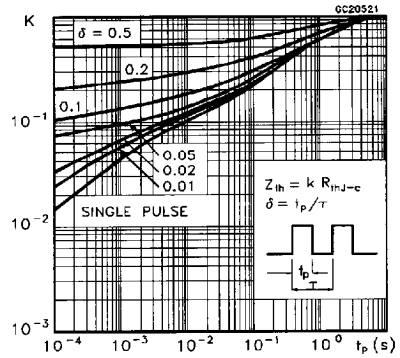
(\bullet) Pulse width limited by safe operating area

**Safe Operating Areas For TO-220****Safe Operating Areas For ISOWATT220**

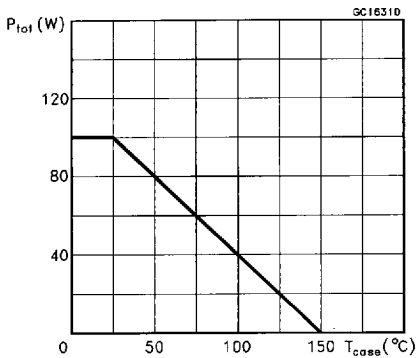
Thermal Impedance For TO-220



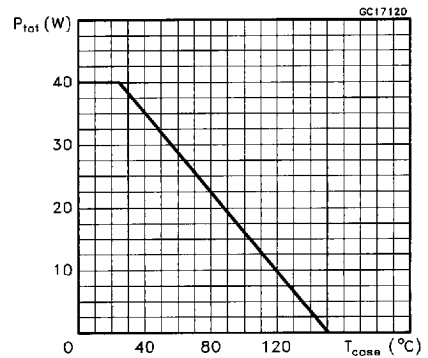
Thermal Impedance For ISOWATT220



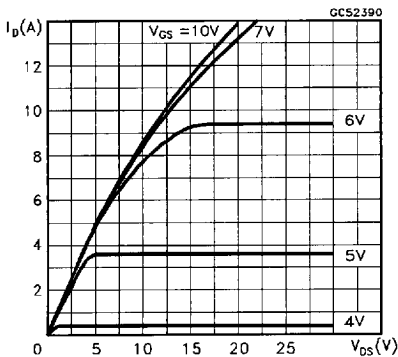
Derating Curve For TO-220



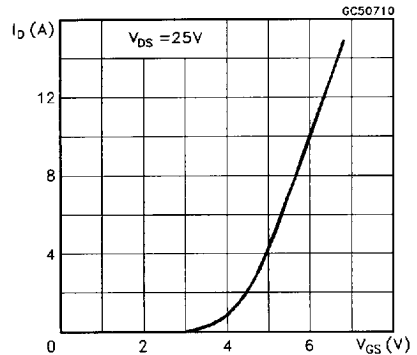
Derating Curve For ISOWATT220



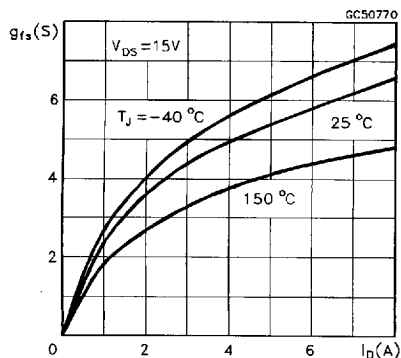
Output Characteristics



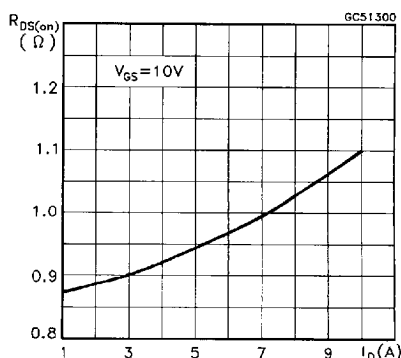
Transfer Characteristics



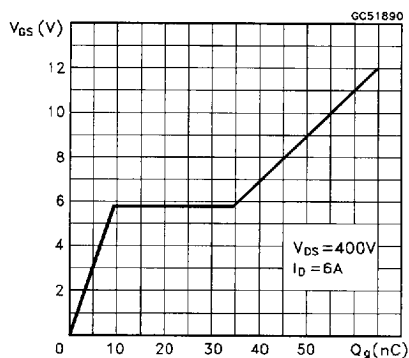
# Transconductance



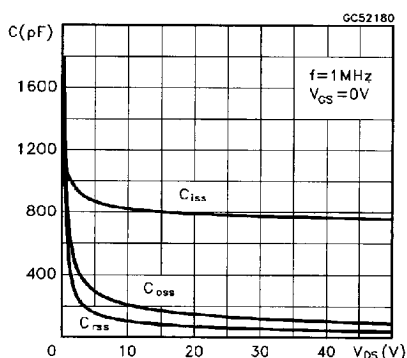
# Static Drain-source On Resistance



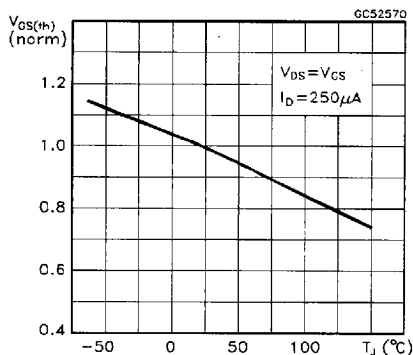
# Gate Charge vs Gate-source Voltage



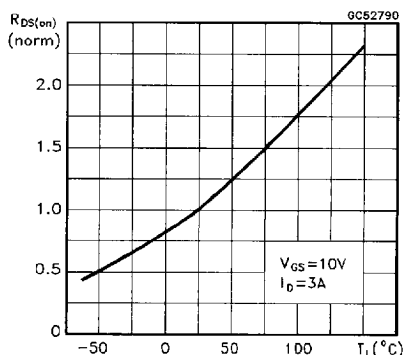
# Capacitance Variations



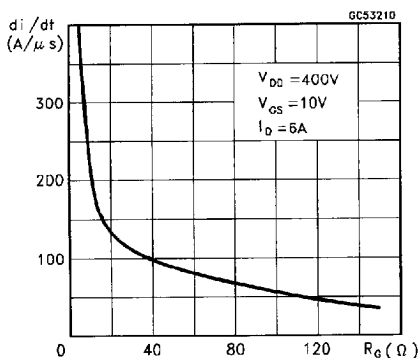
# Normalized Gate Threshold Voltage vs Temperature



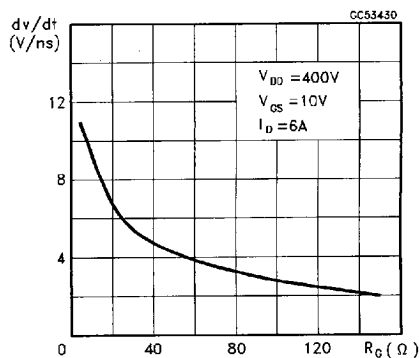
# Normalized On Resistance vs Temperature



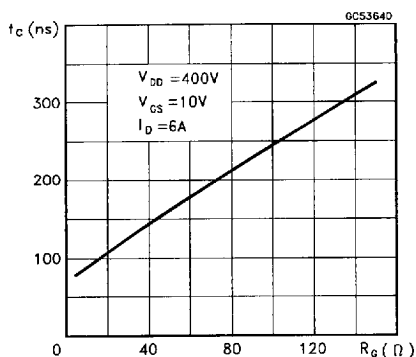
## Turn-on Current Slope



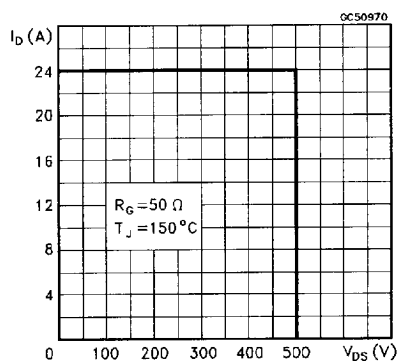
## Turn-off Drain-source Voltage Slope



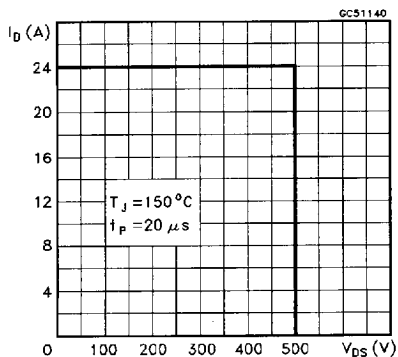
## Cross-over Time



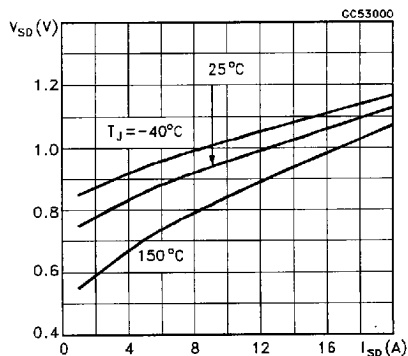
## Switching Safe Operating Area



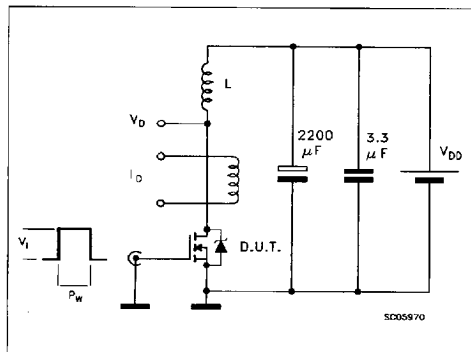
## Accidental Overload Area



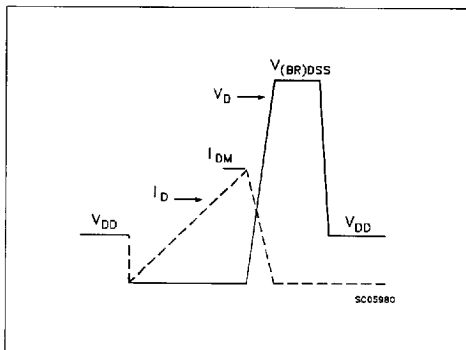
## Source-drain Diode Forward Characteristics



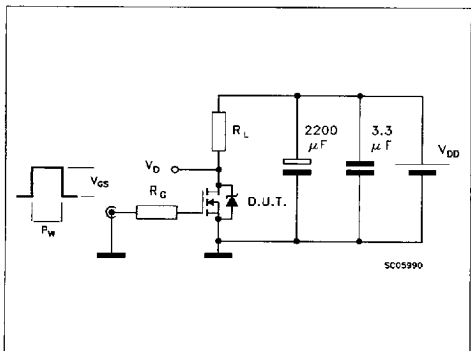
**Fig. 1: Unclamped Inductive Load Test Circuits**



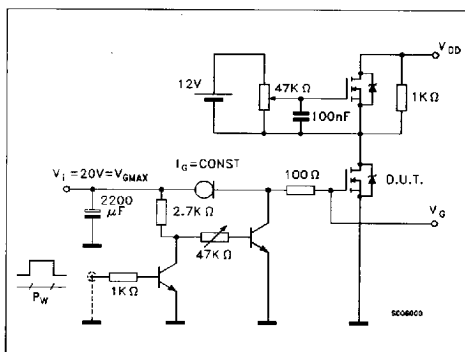
**Fig. 2: Unclamped Inductive Waveforms**



**Fig. 3: Switching Times Test Circuits For Resistive Load**



**Fig. 4: Gate Charge Test Circuit**



**Fig. 5: Test Circuit For Inductive Load Switching And Diode Reverse Recovery Time**

